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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**In re Application of :**

Steve Hsiung et. al.

Serial No. :

09/885,687

Filed :

June 19, 2001

For :Semiconductor Device Package
Substrate Probe Fixture**Group Art Un**

2829

Examiner:

Nguyen, Trung Q.

Attv Docket :

5201-24300 / 01-120/RCE

I hereby certify that this correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to:
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Connie Del Castillo

4/15/04

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Connie del Castillo

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CERTIFICATION UNDER 37 C.F.R. 3.73(b)

Commissioner for Patents
P. O. Box 1450
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Sir:

LSI Logic Corporation, a Delaware corporation, certifies that it is the assignee of the entire right, title and interest in the patent application.

The undersigned has reviewed all the documents in the chain of title of the patent application identified above and, to the best of the undersigned's knowledge and belief, title is in the assignee identified above.

The undersigned (whose title is supplied below) is empowered to act on behalf of the assignee.


I hereby declare that all statements made herein of my own knowledge are true, and that all statements made on information and belief are believed to be true; and further, that these statements are made with the knowledge that willful false statements, and the like so made, are punishable by fine or imprisonment, or both, under Section 1001, Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

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Date:

4/14/04

Respectfully submitted,


Sandeep Jaggi
Chief IP Counsel
Corporate Assistant Secretary
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